

## Evaluates: MAX20011C/MAX20011D

## MAX20011C Evaluation Kit

### General Description

The MAX20011C EV kit is a fully assembled and tested PCB intended to demonstrate the capability of the MAX20011C step-down (buck) voltage regulator. The MAX20011C has an output current rating of 16A. The IC operates at 3V to 5.5V input supply voltage and can regulate to a voltage range of 0.5V to 1.275V.

The MAX20011C features a 2.2MHz fixed-frequency pulse-width-modulation (PWM) mode for better noise immunity and load transient response. The 2.2MHz frequency operation allows for the use of all ceramic capacitors and minimizes external components. The spread-spectrum frequency modulation option minimizes electromagnetic emissions. Integrated low  $R_{DS(ON)}$  switches improve efficiency at heavy loads and simplifies layout.

The MAX20011C is offered with factory-preset output voltage. The I<sup>2</sup>C interface supports dynamic voltage adjustment with programmable slew rates. Other features include programmable soft-start, over-current protection, and over-temperature protection.

The MAX20011D can be evaluated by replacing the installed IC (U1).

### Features

- High Efficiency DC-DC Converter
- Up to 16A Peak Output Current
- Differential Remote Voltage Sensing
- 3V to 5.5V Input Supply Voltage
- I<sup>2</sup>C User Configurable
- Excellent Load Transient Performance
- 2.2MHz or 1.1MHz Operation
- Test Points for Bode Plot Measurement
- Proven PCB Layout
- Fully Assembled and Tested

[Ordering Information](#) appears at end of data sheet.

### Quick Start

#### Required Equipment

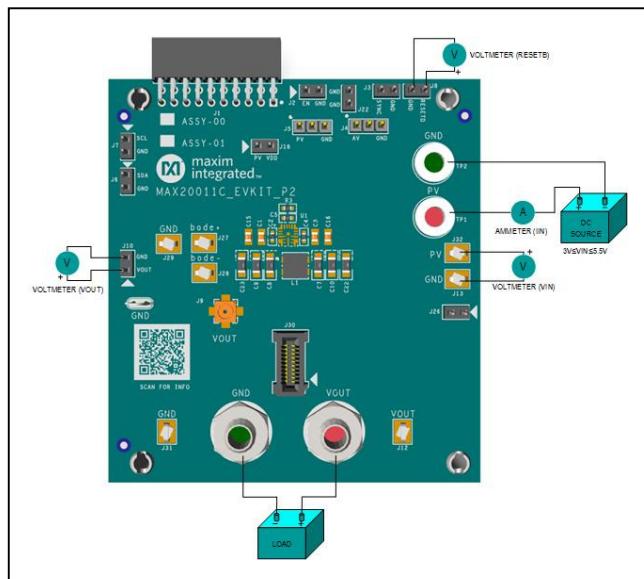
- MAX20011C EV kit
- 8V, 20A power supply
- Load resistor or an electronic load
- Voltmeters
- Ammeter

#### Procedure

The EV kit comes fully assembled and tested. Follow the steps below to verify board operation:

- 1) Connect a 5V power supply to PV (TP1) and GND (TP2). Enable the supply.
- 2) Place jumper (J5) between EN and PV to enable the IC.
- 3) Measure the output voltage at the sense point (J10).
- 4) Connect load between banana sockets TP3 (VOUT) and TP4 (GND).
- 5) Verify that the output voltage at the sense point (J10) remains within specification.
- 6) Verify that RESETB (J8) is at logic-high level.

### Test Setup



319-100574; Rev 2; 7/21

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### Detailed Description of Hardware

#### EV Kit Interface

The banana sockets TP1 (PV) and TP2 (GND) are the main input power supply points on the board. Connect a 5V power supply across these connectors. Use J32 (PV) as a test point for monitoring the input power supply. The banana sockets TP3 (VOUT) and TP4 (GND) serve as outputs to an external load. The MAX20011C is enabled by a jumper placed across the EN and PV pins on jumper J5. The enable signal (EN) can be monitored at test point J2, and the RESET signal (RESETB) is monitored at test point J8. The 20-pin connector J1 is a socket for an optional I<sup>2</sup>C interface board (not included). The I<sup>2</sup>C SDA and SCL signals are monitored at test points J6 (SDA) and J7 (SCL). Use test points J27 (Bode+) and J28 (Bode-) for bode plot measurements, and J10 for measuring output voltage at the sense point (a differential probe is recommended for ripple and transient measurements).

#### MAX20011C EV Kit Jumpers, Test Points, and Connectors

JUMPER	SIGNAL	DEFAULT POSITION	FUNCTION
J1	NA	NA	Connector for optional I <sup>2</sup> C communication module
J2	EN	NA	Test point for device enable (EN) signal
J3	SYNC	NA	Test point for external synchronization (SYNC) signal
J4	SYNC	NA	Connection point for applying an external synchronization signal
J5	EN	OFF	Jumper for device enable (EN) signal
J6	SDA	NA	Test point for I <sup>2</sup> C SDA signal
J7	SCL	NA	Test point for I <sup>2</sup> C SCL signal
J8	RESETB	NA	Test point for RESET (RESETB)
J9	VOUT	NA	Test point for output voltage
J10	RS+	NA	Test point for output sense point
J12	VOUT	NA	Test point for output voltage
J13	GND	NA	Ground
J18	VDD	NA	VDD to PV connector (Not required for MINIQUUSB)
J22	GND	NA	Ground
GND	GND	NA	Ground
J26	LX	NA	Test point for LX signal with R-C filter
J27	Bode+	NA	Test point for bode plot measurement
J28	Bode-	NA	Test point for bode plot measurement
J29	GND	NA	Ground
J30	Plugin socket	NA	Socket for optional load transient board (MAXLDBD)
J31	GND	NA	Ground
J32	PV	NA	Test point for input voltage during efficiency measurement

#### Ordering Information

PART	TYPE
MAX20011CEVKIT#	EV Kit

#Denotes RoHS compliance.

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### MAX20011C EV Kit Bill of Materials

REFERENCE	VALUE	DESCRIPTION	MANUFACTURER	MFG PART #
C1, C3, C15, C16	10UF	CAPACITOR; SMT (0805); CERAMIC CHIP; 10UF; 10V; TOL=20%; TG=-55 DEGC TO +125 DEGC; TC=X7S;	TDK	CGA4J3X7S1A106M125AB
C2, C4	1UF	CAPACITOR; SMT (0603); CERAMIC CHIP; 1UF; 25V; TOL=10%; TG=-55 DEGC TO +125 DEGC; TC=X7R	TDK	CGA3E1X7R1E105K
C5	2.2UF	CAPACITOR, 0603,CERAMIC, 2.2UF, 10V, X7S	TDK	CGA3E3X7S1A225K080AE
C6	0.1UF	CAPACITOR, 0603, CERAMIC, 0.1UF, 25V, X7R	TDK	C1608X7R1E104K080AA
C7 - C14	47UF	CAP; SMT (1206); 47UF; 20%; 4V; CERAMIC CHIP	TDK	CGA5L1X7T0G476M
C17	470UF	CAPACITOR, 7343, TANTALUM POLYMER, 470UF, 6.3V	KEMET	T530X477M006ATE004
C18 - C21	47UF	47µF ±20% 10V Ceramic Capacitor X7S 1210	TDK	CGA6P1X7S1A476M
GND	-	TEST POINT; PIN DIA=0.094IN; PHOSPHOR BRONZE WIRE SILVER PLATE FINISH	KEYSTONE	5020
J1	-	CONNECTOR; FEMALE; THROUGH HOLE; BREAKAWAY HEADER; RIGHT ANGLE; 20PINS	SULLINS ELECTRONIC CORP	PPTC102LJBN-RC
J2, J3, J6-J8, J10, J18, J22, J26	-	CONNECTOR; MALE; THROUGH HOLE; TSW SERIES; DOUBLE ROW; STRAIGHT; 2PINS	SAMTEC	TSW-101-07-L-D
J4, J5	-	CONNECTOR; THROUGH HOLE; SINGLE ROW; STRAIGHT; 3PINS; -55 DEGC TO +125 DEGC	SAMTEC	TSW-103-23-G-S
J9	-	MICROMATE FEMALE SURFACE MOUNT MMCX CONNECTOR	AMPHENOL	908-22101

## MAX20011C Evaluation Kit

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### MAX20011C EV Kit Bill of Materials (continued)

REFERENCE	VALUE	DESCRIPTION	MANUFACTURER	MFG PART #
J12, J13, J27-J29, J31, J32	-	TEST POINT; SMT; SILVER; PHOSPHOR BRONZE WITH SILVER PLATE CONTACT	KEYSTONE	5016
J30	-	CONNECTOR; FEMALE; SMT; MINI SLAMMER SOCKET; STRAIGHT; 20PINS	SAMTEC	HSEC8-110-01-S-DV-A
L1	70nH	EVKIT PART - INDUCTOR; SMT; FERRITE; 70NH; 20%; 34A	TDK	HPL505028F070MRD3P
R1, R2, R8	1K	RESISTOR; 0603; 1K; 1%; 100PPM; 0.10W; THICK FILM	PANASONIC	ERJ-3EKF1001
R3	2.2	RESISTOR, 0603, 2.2 OHM, 1%, 100PPM, 0.10W, THICK FILM	PANASONIC	ERJ-3RQF2R2
R4, R5	10K	RESISTOR; 0603; 10K; 1%, 100PPM, 0.10W, THICK FILM	PANASONIC	ERJ-3EKF1002
R6	10	RESISTOR; 0402; 10 OHM, 1%; 100PPM; 0.063W, THICK FILM	VISHAY DALE	CRCW040210R0FK
R7	0	RESISTOR; 0402; 0 OHM; 0%, 0.10W, THICK FILM	PANASONIC	ERJ-2GE0R00
TP1, TP2	-	RECEPTACLE; JACK; BANANA; NICKEL PLATED BRASS	KEYSTONE	575-8
TP3, TP4	-	CONNECTOR; MALE; PANELMOUNT; BANANA JACK; STRAIGHT; 1PIN	EMERSON NETWORK POWER	108-0740-001
U1	MAX20011C	IC; AUTOMOTIVE SINGLE 16A STEP- DOWN CONVERTER FAMILY	MAXIM INTEGRATED	MAX20011CAFOA/VY+

**MAX20011C EV Kit Schematic**

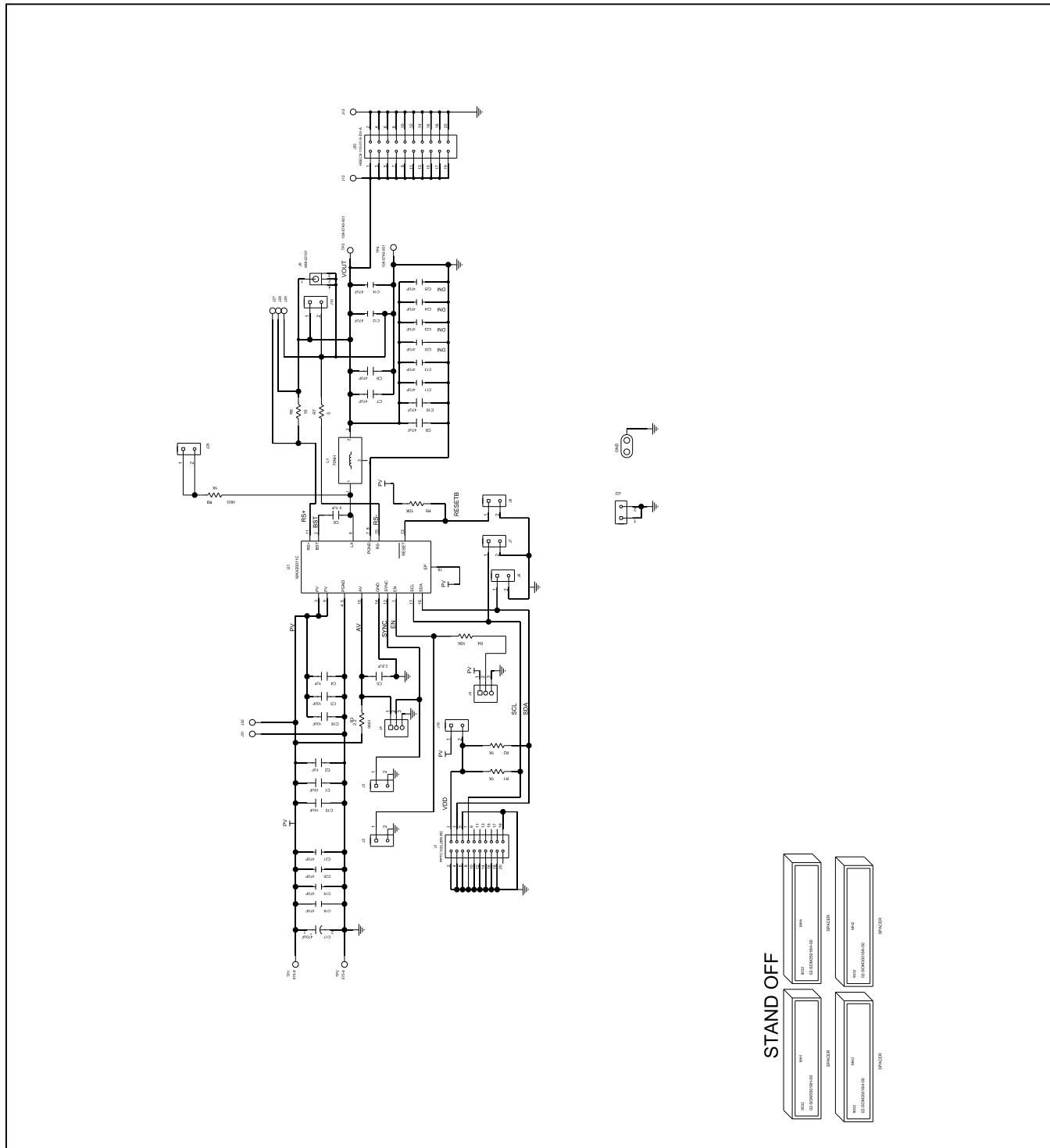


Figure 1. MAX20011C EV Kit Schematic

## MAX20011C Evaluation Kit

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MAX20011D

### MAX20011C EV Kit PCB Layout Diagrams

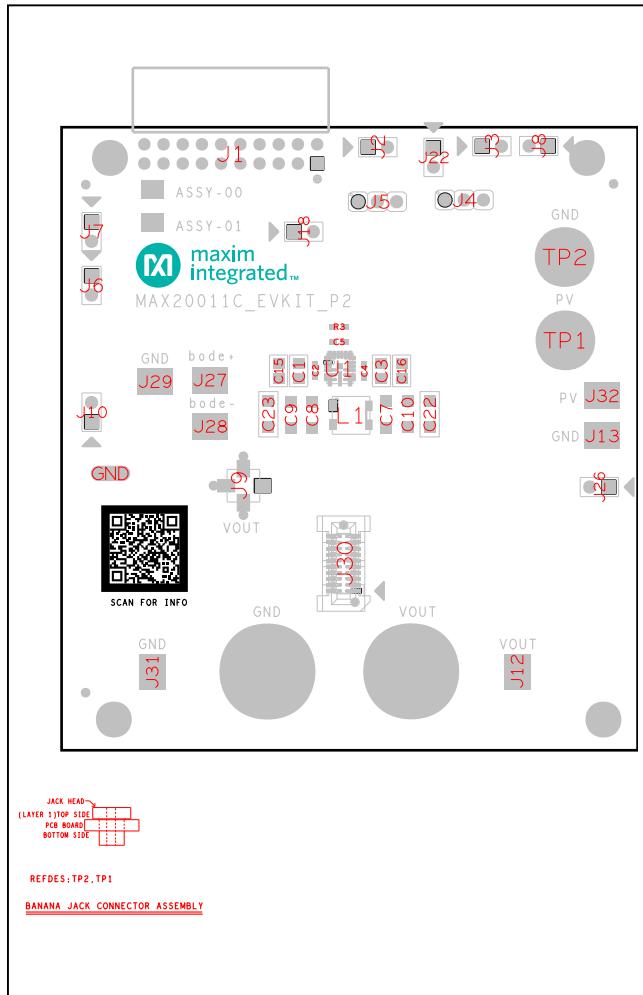


Figure 2. MAX20011C EV Kit PCB Layout—Top Assembly

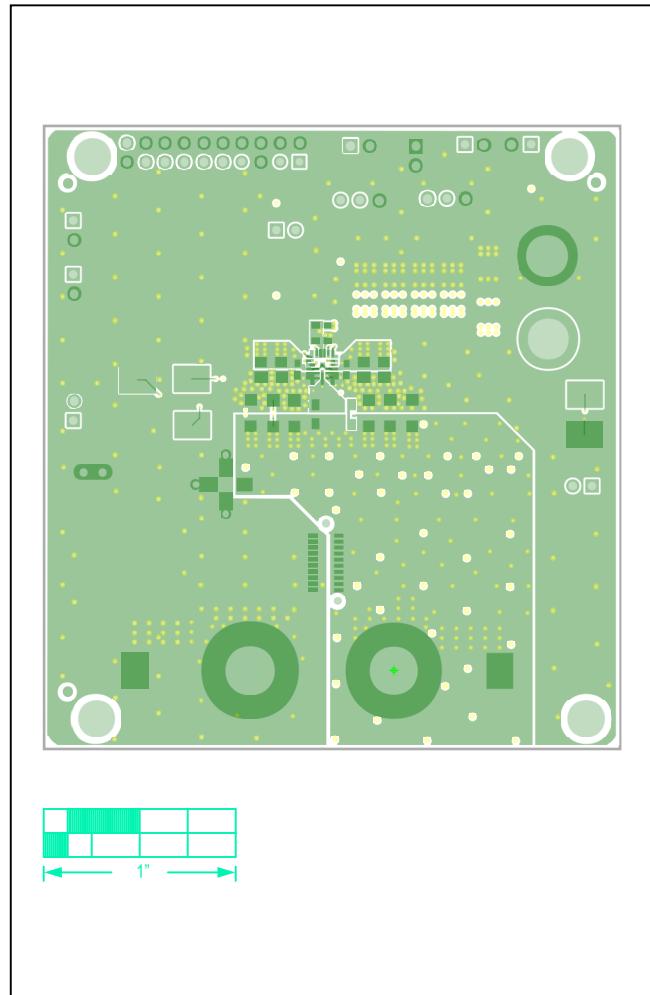


Figure 3. MAX20011C EV Kit PCB Layout—Top Layer

**MAX20011C EV Kit PCB Layout Diagrams (continued)**

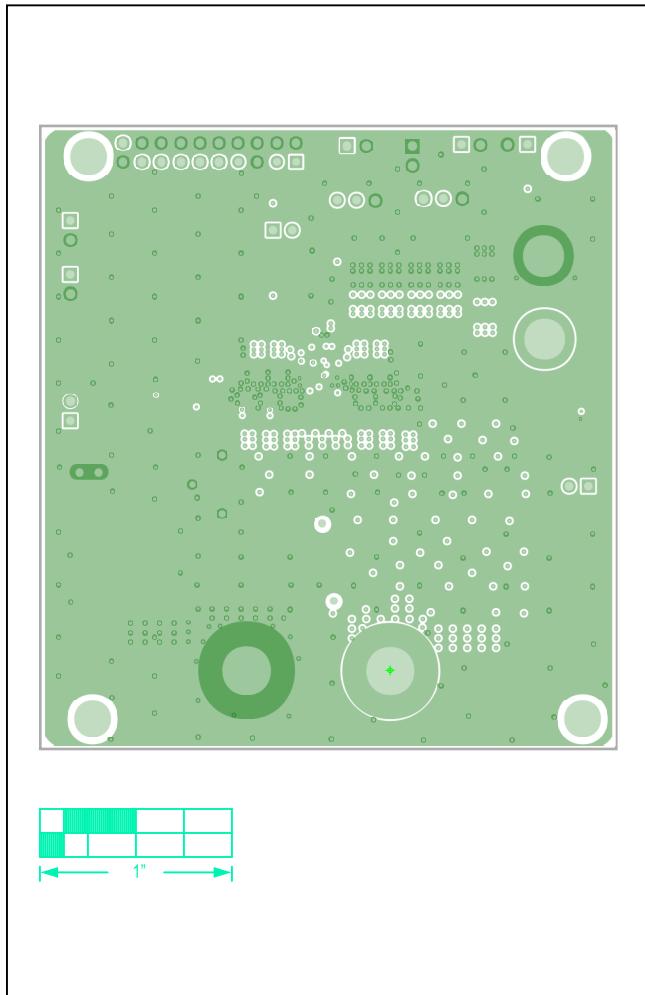


Figure 4. MAX20011C EV Kit PCB Layout—Inner Layer 2

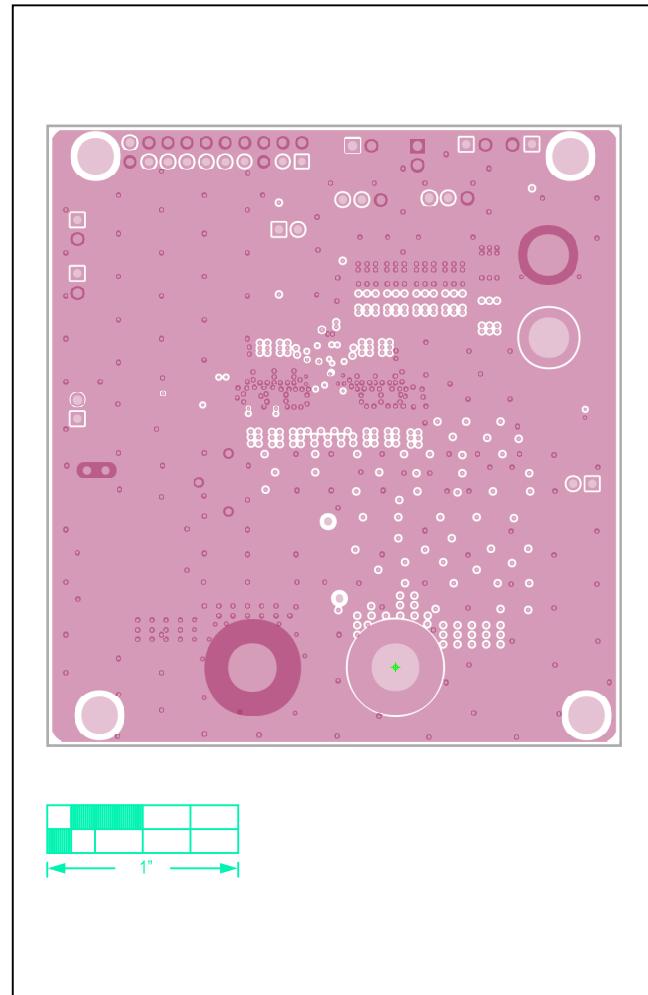


Figure 5. MAX20011C EV Kit PCB Layout—Inner Layer 3

**MAX20011C EV Kit PCB Layout Diagrams (continued)**

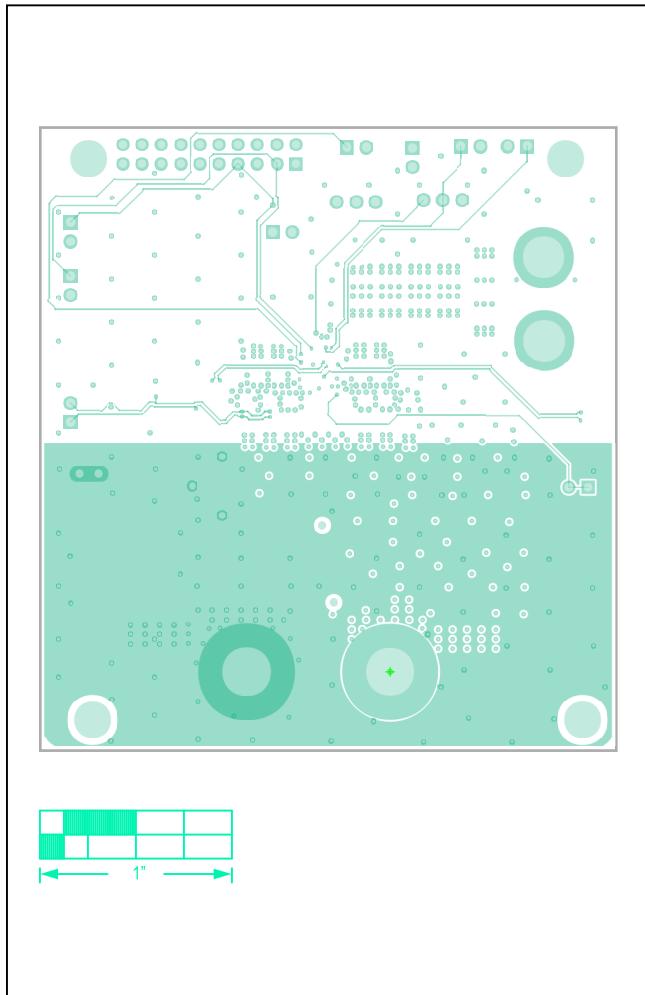


Figure 6. MAX20011C EV Kit PCB Layout—Inner Layer 4

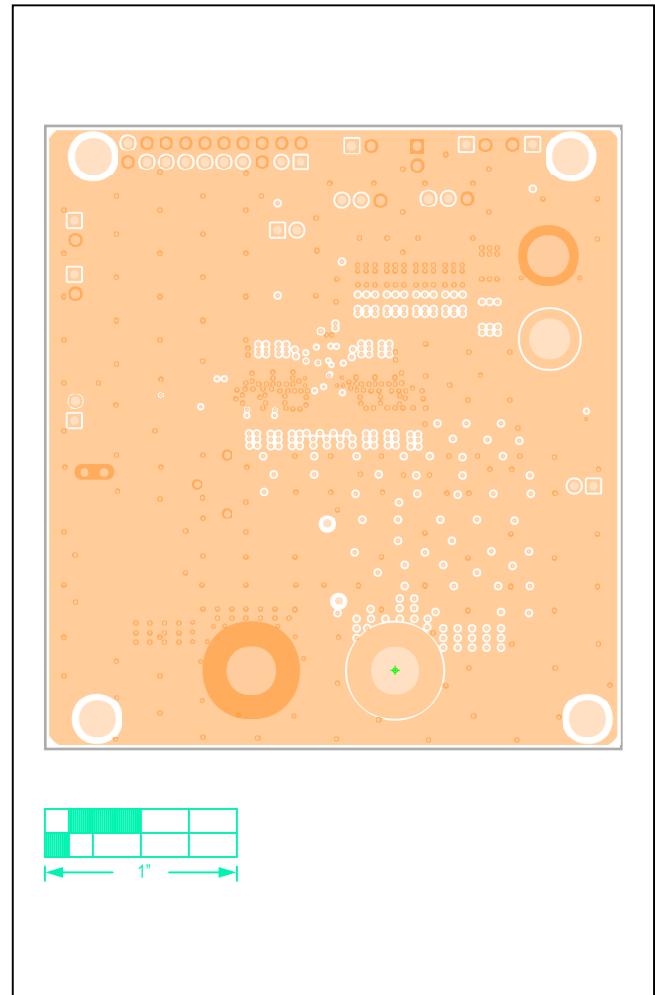


Figure 7. MAX20011C EV Kit PCB Layout—Inner Layer 5

**MAX20011C EV Kit PCB Layout Diagrams (continued)**

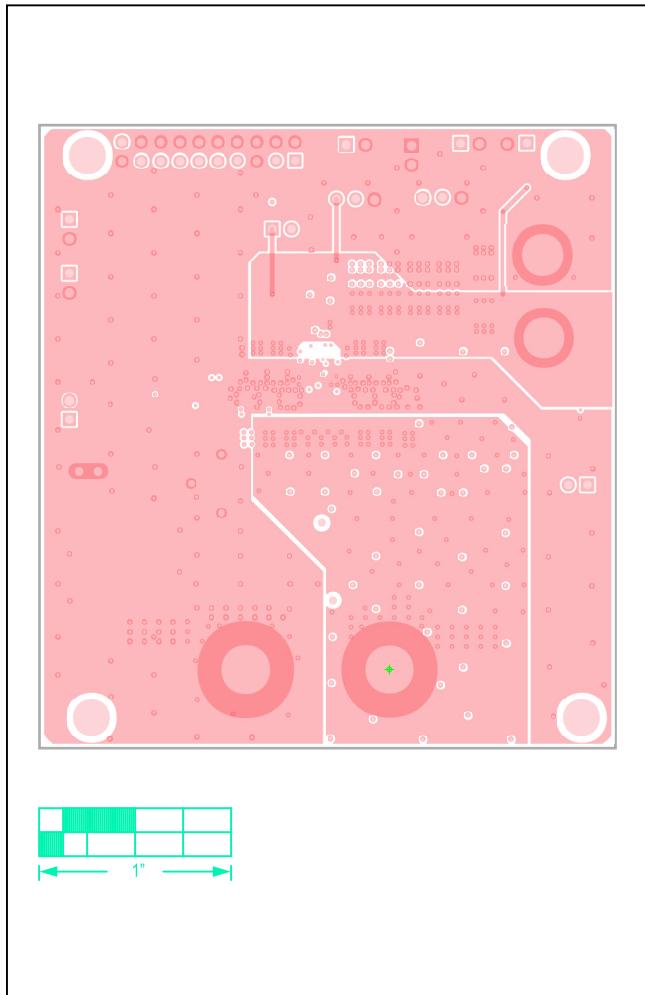


Figure 8. MAX20011C EV Kit PCB Layout—Inner Layer 6

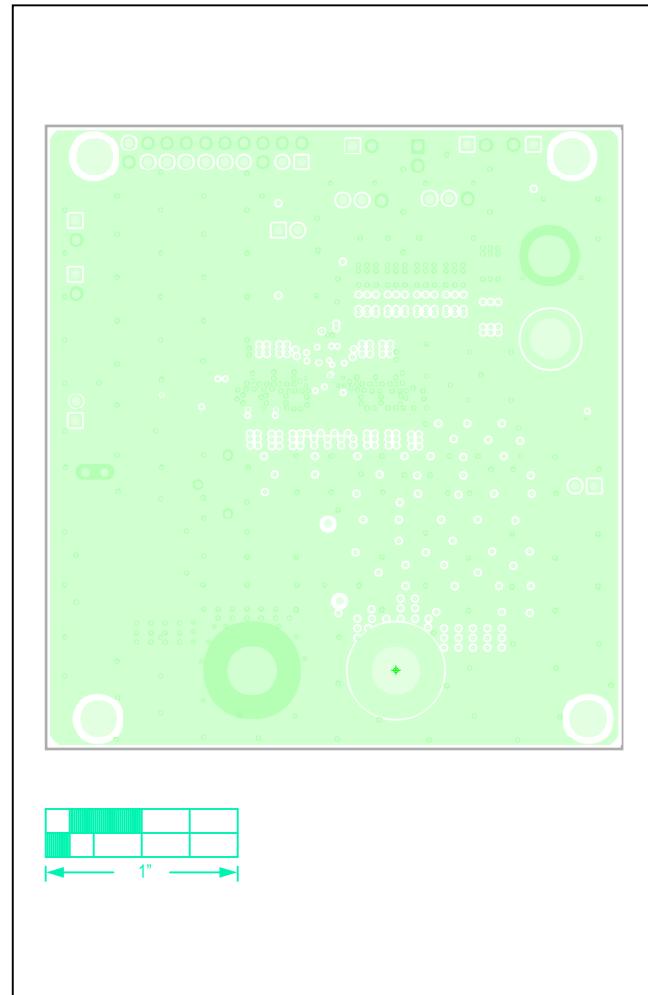


Figure 9. MAX20011C EV Kit PCB Layout—Inner Layer 7

**MAX20011C EV Kit PCB Layout Diagrams (continued)**

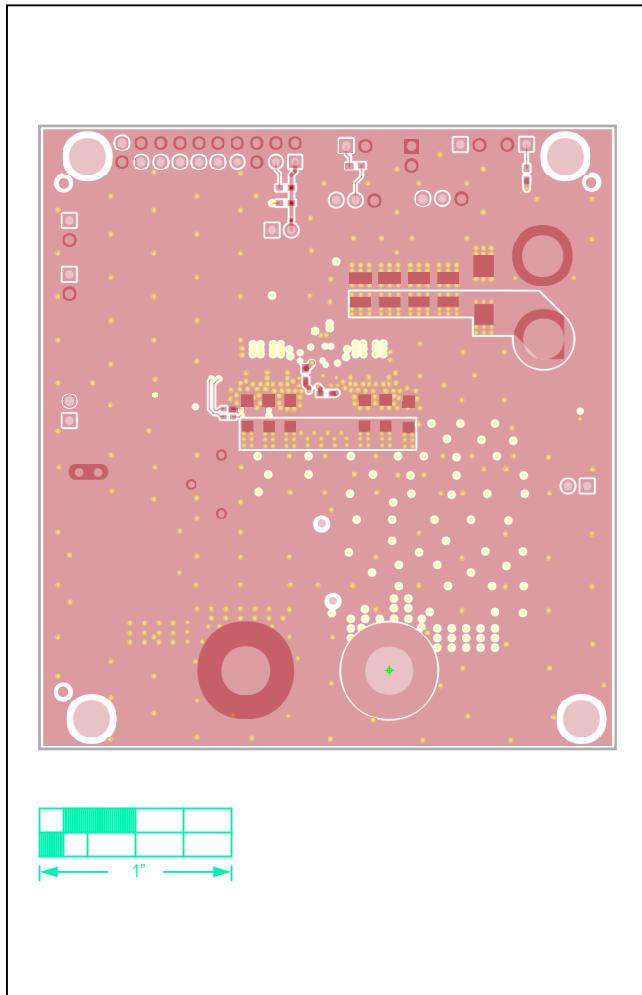


Figure 10. MAX20011C EV Kit PCB Layout—Bottom Layer

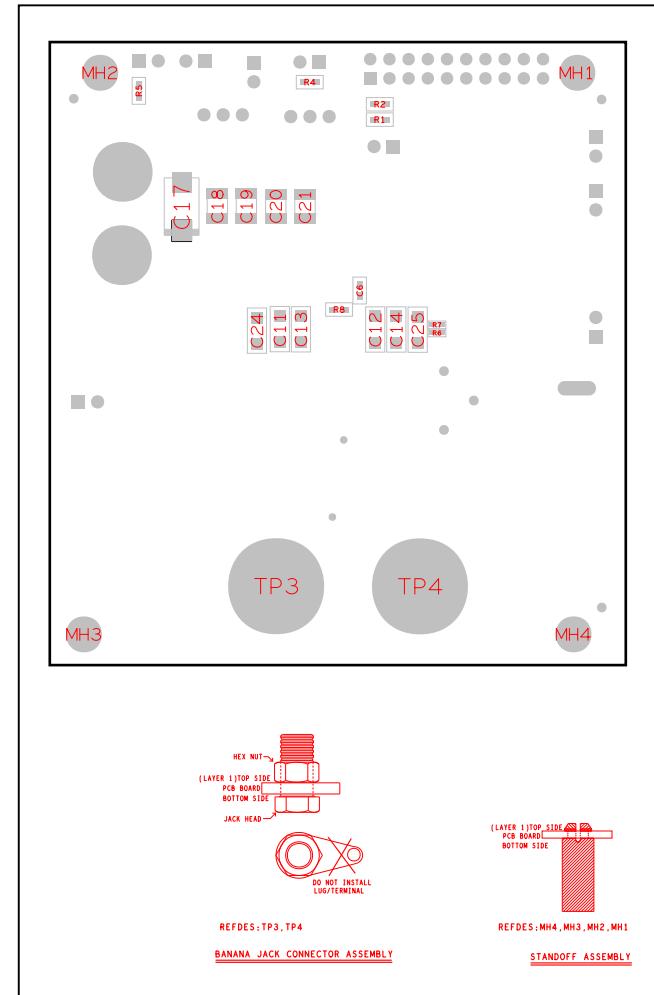


Figure 11. MAX20011C EV Kit PCB Layout—Bottom Assembly

## MAX20011C Evaluation Kit

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### Revision History

REVISION NUMBER	REVISION DATE	DESCRIPTION	PAGES CHANGED
0	8/20	Initial release	—
1	12/20	Removed MAX20011CEVKITSYS# from <i>Ordering Information</i>	2
2	7/21	Added MAX20011D to title; updated <i>General Description</i>	All



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